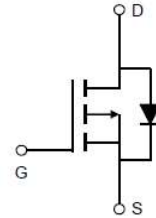


**P-Channel Enhancement Mosfet**

**Features**

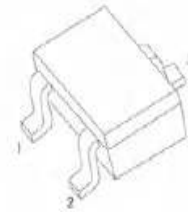
- -100V,-3A  
 $R_{DS(ON)} < 370m\Omega @ V_{GS} = -10V$  TYP:285m $\Omega$   
 $R_{DS(ON)} < 405m\Omega @ V_{GS} = -4.5V$  TYP:305 m $\Omega$
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired
- P/N suffix V means AEC-Q101 qualified, e.g:RM3P100YV



Schematic diagram

**Applications**

- PWM Applications
- Load Switch
- Power Management
- Halogen-free



SOT23-3L

**Package Marking and Ordering Information**

Device Marking	Device	Package	Packaging Code	Reel Size	Quantity(Pcs)	Carton(Pcs)
3P10A	RM3P100YV	SOT23-3L	-T	7inch	3000	120000

**ABSOLUTE MAXIMUM RATINGS (T<sub>J</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	-100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current (T <sub>a</sub> =25°C)	I <sub>D</sub>	-3	A
Continuous Drain Current (T <sub>a</sub> =100°C)	I <sub>D</sub>	-1.8	A
Pulsed Drain Current <sup>(1)</sup>	I <sub>DM</sub>	-12.0	A
Drain Power Dissipation	P <sub>D</sub>	1.25	W
Avalanche energy <sup>(2)</sup>	E <sub>AS</sub>	12.5	mJ
Thermal Resistance- Junction to Ambient	R <sub>θJA</sub>	100	°C/W
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-55~ +150	°C

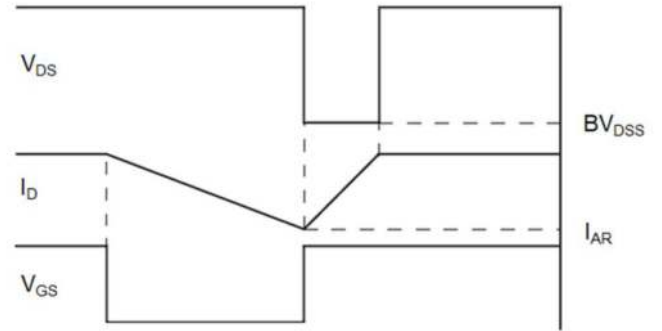
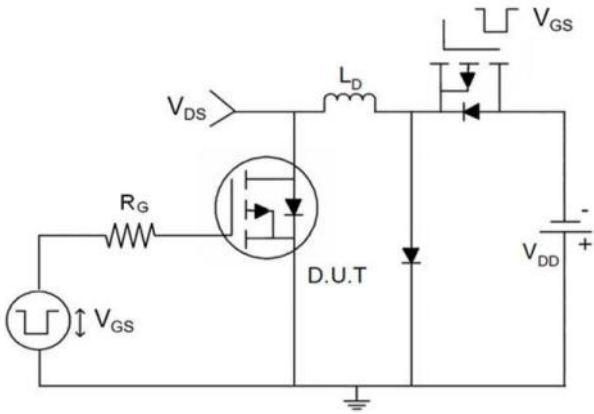
## MOSFET ELECTRICAL CHARACTERISTICS( $T_J=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-100	-	-	V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -100V, V_{GS} = 0V$	-	-	-1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-1.0	-	-2.5	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -3A$	-	285	370	m $\Omega$
		$V_{GS} = -4.5V, I_D = -3A$	-	305	405	m $\Omega$
<b>Dynamic characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -50V, V_{GS} = 0V, f = 1.0MHz$	-	1199	-	pF
Output Capacitance	$C_{oss}$		-	34	-	
Reverse Transfer Capacitance	$C_{rss}$		-	28.2	-	
Gate resistance	$R_G$	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	-	5.2	-	$\Omega$
<b>Switching characteristics</b>						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -50V, I_D = -3A, R_G = 3\Omega,$ $V_{GS} = -10V, R_L = 16.6\Omega$	-	13.5	-	ns
Turn-on rise time	$t_r$		-	3.8	-	
Turn-off delay time	$t_{d(off)}$		-	42	-	
Turn-off fall time	$t_f$		-	6.4	-	
Total Gate Charge	$Q_g$	$V_{DS} = -50V,$ $I_D = -3A, V_{GS} = -10V$	-	19.6	-	nC
Gate-Source Charge	$Q_{gs}$		-	6	-	
Gate-Drain Charge	$Q_{gd}$		-	4.2	-	
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage	$V_{SD}$	$T_c = 25^{\circ}\text{C}, V_{GS} = 0V, I_S = -3A$	-	-	-1.2	V
Diode Forward current	$I_S$	$T_c = 25^{\circ}\text{C}$	-	-	-3	A
Body Diode Reverse Recovery Time	$t_{rr}$	$T_c = 25^{\circ}\text{C}, I_F = -3A, di/dt = 100A/\mu s$		42.9		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	$T_c = 25^{\circ}\text{C}, I_F = -3A, di/dt = 100A/\mu s$		83.7		uc

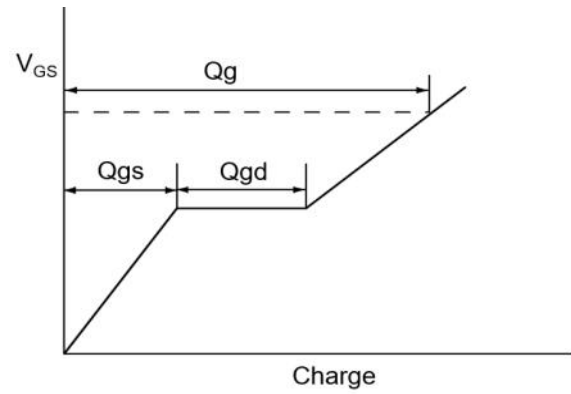
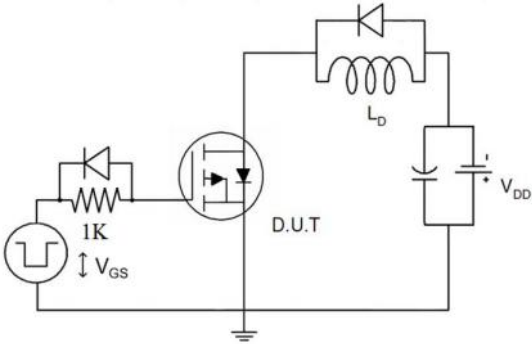
### Notes:

- 1.Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2.EAS condition:  $T_J=25^{\circ}\text{C}, V_{DD}=-50V, V_G=-10V, R_G=25\Omega, L=0.5mH$ .

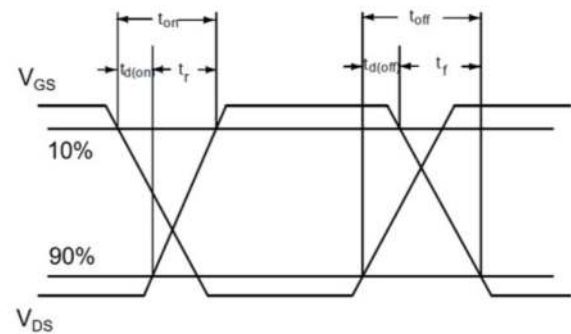
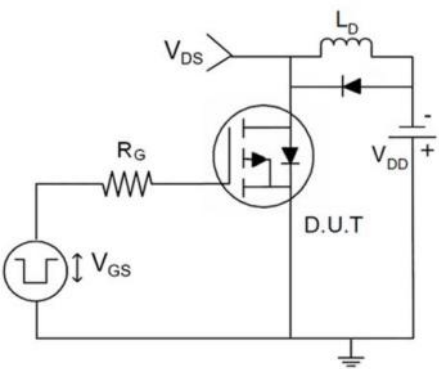
### 1) $E_{AS}$ Test Circuits



### 2) Gate Charge Test Circuit



### 3) Switch Time Test Circuit



# RATING AND CHARACTERISTICS CURVES (RM3P100YV)

Figure 1. Output Characteristics

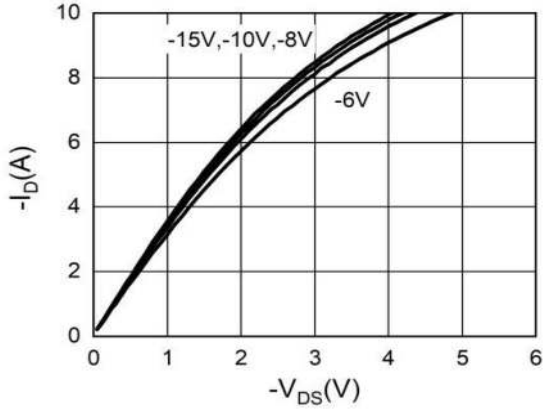


Figure 2. Transfer Characteristics

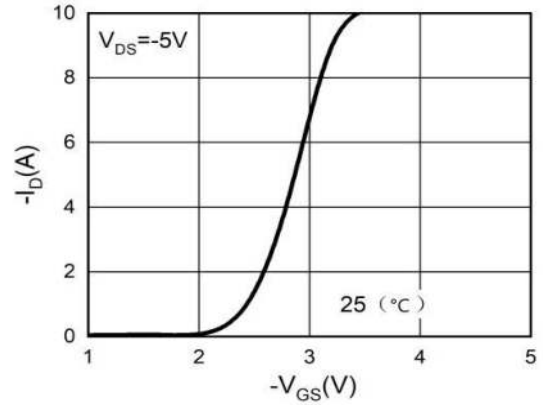


Figure 3. Power Dissipation

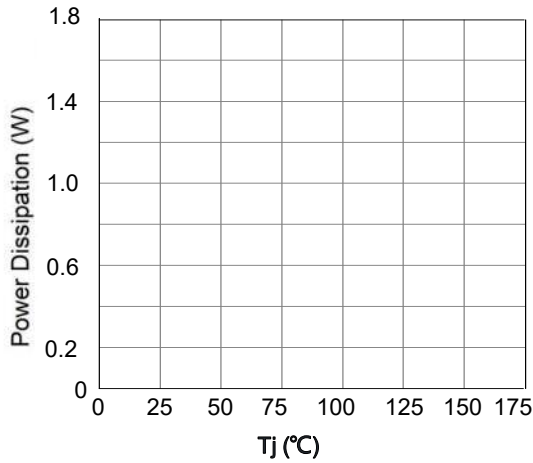


Figure 4. Drain Current

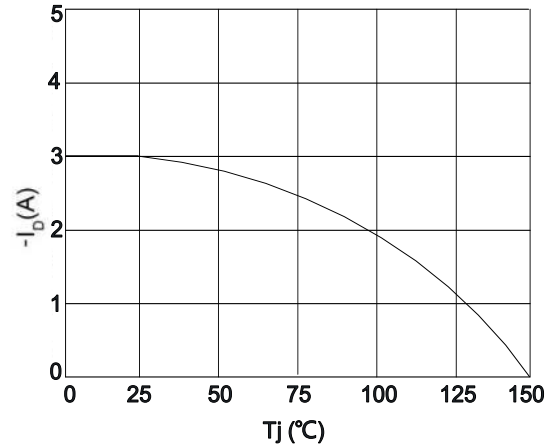


Figure 5.  $BV_{DSS}$  vs Junction Temperature

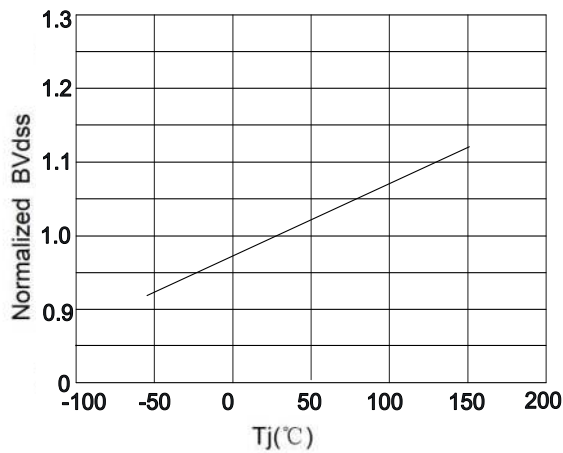
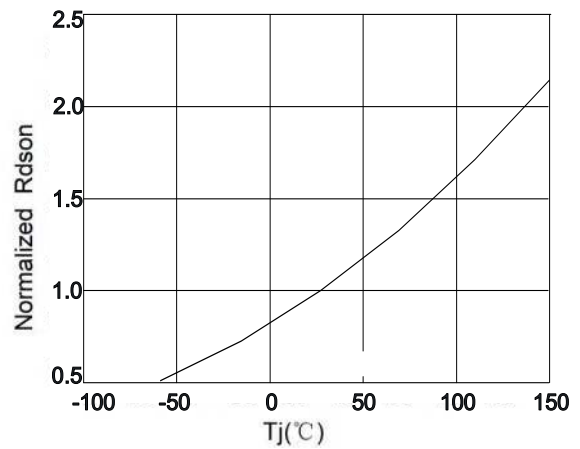


Figure 6.  $R_{DS(ON)}$  vs Junction Temperature



# RATING AND CHARACTERISTICS CURVES (RM3P100YV)

Figure 7. Gate Charge Waveforms

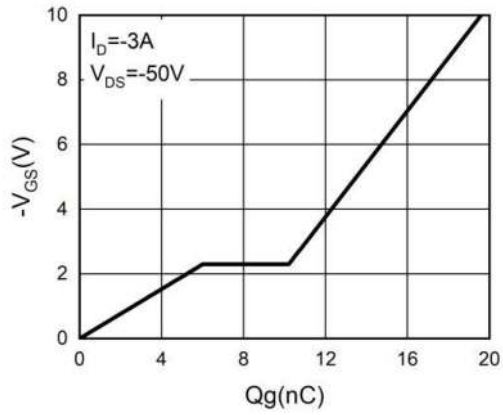


Figure 8. Capacitance

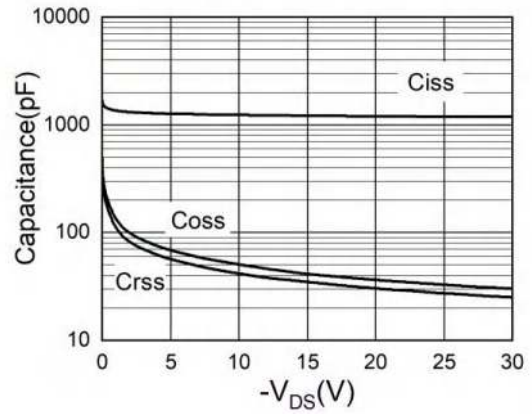


Figure 9. Body-Diode Characteristics

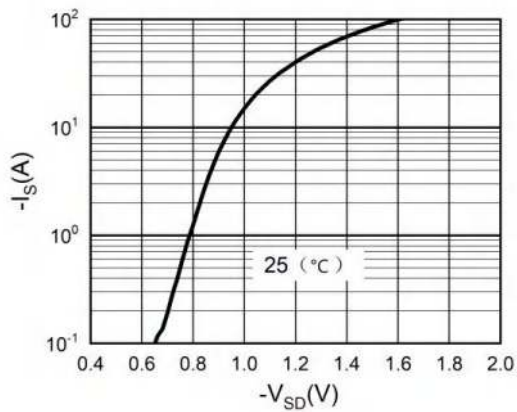
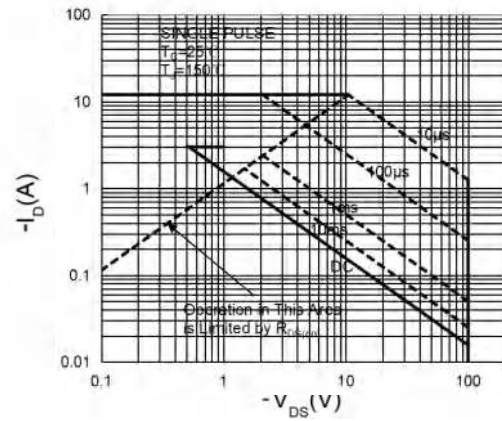
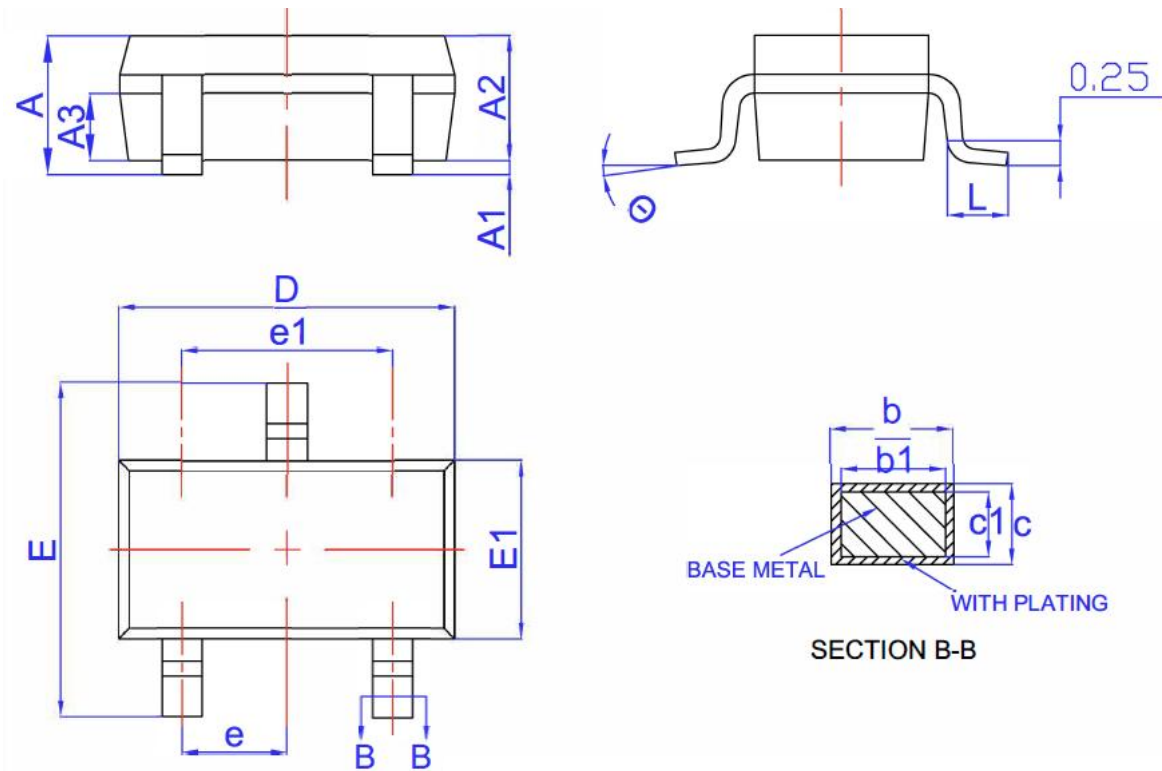


Figure 10. Maximum Safe Operating Area



# Package Information SOT23-3L



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	—	—	1.25
A1	0.04	—	0.10
A2	1.00	1.10	1.20
A3	0.55	0.65	0.75
b	0.38	—	0.48
b1	0.37	0.40	0.43
c	0.11	—	0.21
c1	0.10	0.13	0.16
D	2.72	2.92	3.12
E	2.60	2.80	3.00
E1	1.40	1.60	1.80
e	0.95BSC		
e1	1.90BSC		
L	0.30	—	0.60
$\ominus$	0	—	8°

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